

Number : KSEI-0725/DIR/0226
Attachment : -
Letter Classification : General

February 3, 2026

To: Board of Directors of Account Holders

Indonesia Central Securities Depository (KSEI)

Re: Registration of Bank Panin Shelf-Registration Bond IV Phase IV Year 2026

Dear Sir/Madam,

We hereby inform you that PT Bank Pan Indonesia Tbk will hold a public offering for the Bank Panin Shelf-Registration Bond IV, with a maximum total fundraise target of Rp15,000,000,000,000, (fifteen trillion rupiahs).

The Company has issued and offered the following:

Securities Name	Distributed Amount	Distribution Date
Bank Panin Shelf-Registration Bond IV Phase I Year 2024	Rp50,000,000,000	July 5, 2024
Bank Panin Shelf-Registration Bond IV Phase II Year 2024	Rp3,910,000,000,000	October 8, 2024
Bank Panin Shelf-Registration Bond IV Phase III Year 2025	Rp3,200,000,000,000	September 4, 2025

In relation to the sustainable public offering, the Company will issue and offer the Bank Panin Shelf-Registration Bond IV Phase IV Year 2026, with a maximum total principal of Rp2,712,000,000,000 (two trillion seven hundred twelve billion rupiahs), with details as follows:

Series	Principal Amount	Coupon Type and Rate (Fixed)	Coupon Payment Frequency	Maturity Date	Tenure
A	Rp1,708,000,000,000	5.90 % p.a	Quarterly	February 25, 2029	3 Years
B	Rp1,004,000,000,000	6.15 % p.a	Quarterly	February 25, 2031	5 Years

The Bank Panin Shelf-Registration Bond IV Phase V and/or subsequent phases (if there are any) will be determined at a later time.

As part of our commitment to Good Corporate Governance, KSEI has implemented an Anti-Bribery Management System applicable to all KSEI personnel. If you become aware of any violations related to this matter, please report them through KSEI's official email address for reporting violations at lapor@kseiwbs.co.id.

The Shelf-Registration Bond's Public Offering will be scheduled as follows:

Effective Date	:	June 27, 2024
Public Offering Period	:	February 13 – 20, 2026
Allotment Date	:	February 23, 2026
Order Refund Date	:	February 25, 2026
Bond Electronic Distribution Date	:	February 25, 2026
Listing Date in the Indonesia Stock Exchange	:	February 26, 2026
First Bond Coupon Payment Date	:	May 25, 2026
Bond Lead Underwriter and Underwriter	:	PT Evergreen Sekuritas Indonesia PT Aldiracita Sekuritas Indonesia PT Korea Investment and Sekuritas Indonesia PT Sinarmas Sekuritas PT Sucor Sekuritas

Thank you for your kind attention and cooperation.

Sincerely yours,

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Director of Settlement, Custodian Services,
and Surveillance

Yulia Purnama Sari

Head of Custodian Services Division

CC:

1. Board of Commissioners of the Financial Services Authority (OJK) – Attn. Chief Executive of Capital Market Supervision
2. Indonesia Stock Exchange (IDX)
3. PT Bank Mandiri (Persero) Tbk as Trustee
4. PT Bank Pan Indonesia Tbk.

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